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## Thermal conductivity switch: Optimal semiconductor/metal melting transition

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#### Thermal conductivity switch: optimal semiconductor/metal melting transition

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#### Abstract

Scrutinizing distinct solid/liquid (s/l) and solid/solid (s/s) phase transitions (passive transitions) for large change in bulk (and homogenous) thermal conductivity, we find the s/l semiconductor/metal (S/M) transition produces largest dimensionless thermal conductivity switch (TCS) figure of merit  $Z_{\text{TCS}}$  (change in thermal conductivity divided by smaller conductivity). At melting temperature, the solid phonon and liquid molecular thermal conductivities are comparable and generally small, so the TCS requires localized electron solid and delocalized electron liquid states. For cyclic phase reversibility, the congruent phase transition (no change in composition) is as important as the thermal transport. We identify XSb and XAs (X = Al, Cd, Ga, In, Zn) and describe atomic-structural metrics for large  $Z_{\text{TCS}}$ , then show the superiority of S/M phonon- to electrondominated transport melting transition. We use existing experimental results and theoretical and ab initio calculations of the related properties for both phases (including the Kubo-Greenwood and Bridgman formulations of liquid conductivities). The 5p orbital of Sb contributes to the semiconductor behavior in the solid-phase bandgap and upon disorder and bond-length changes in the liquid phase this changes to metallic, creating the large contrast in thermal conductivity. The charge density distribution, electronic localization function, and electron density of states are used to mark this S/M transition. For optimal TCS, we examine the elemental selection from the transition-, basic- and semimetals and semiconductor groups. For CdSb, addition of residual Ag suppresses the bipolar conductivity and its  $Z_{\text{TCS}}$  is over 7, and for  $\text{Zn}_3\text{Sb}_2$  it is expected to be over 14, based on the structure and transport properties of the better known  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub>. This is the highest  $Z_{\text{TCS}}$  identified. In addition to the metallic melting, the high  $Z_{\text{TCS}}$  is due to the electron-poor nature of II-V semiconductors leading to the significantly low phonon conductivity.

#### I. INTRODUCTION

The thermal conductivity switch (TCS) is the phenomenon of significant change in thermal conductivity at a distinct temperature, under an external field or by other means. The TCS performance may be assessed by the ratio of this thermal conductivity change to the smaller of the thermal conductivities, i.e.,  $\Delta k/k_{\rm min} = Z_{\rm TCS}$  which is called the TCS figure of merit here. The  $\Delta k$  mechanisms are classified in detail in Section II by thorough examination of the various thermal energy carriers, namely, phonon, electron (and hole), fluid particle and photon, and transitions. The phonon conductivity  $(k_p)$  in the solid phase increases as  $T^3$  at low temperatures (< 0.1  $T_{\rm D}$ , Debye temperature) due to the increase in specific heat, and decreases as  $T^{-1}$  at high temperatures area mainly due to dominant phonon-phonon scattering (mostly by the Umklapp processes)<sup>1</sup>. So,  $k_p$  becomes rather small near the melting temperature  $(T_{sl})$ . After melting, the fluid (liquid or melt) particles replaces the solid phonons with the fluid-particle thermal conductivity  $k_f$ , which is lower but generally comparable to  $k_p$  at  $T_{sl}$ , as the softened lattice turns into random structure of liquid.

The electronic thermal conductivity  $(k_e)$  increases from dielectrics to semiconductors to metals and for metals it becomes independent of temperature near  $T_{sl}{}^1$ , for intrinsic semiconductors it increases with temperature (increase in the conduction electron density  $n_{e,c}$ )<sup>2</sup> unless the electron mobility  $\mu_e$  significantly decreases with temperature. The  $k_e$  for semiconductors is much smaller than that of metals, through the generally accepted (even for semiconductors) Wiedemann-Franz (W-F) law ( $k_e = N_{\rm L}T\sigma_e$ , where  $N_{\rm L}$  is the Lorenz number and  $\sigma_e$  is the electrical conductivity), which is also applicable to liquids. So, we expect at melting TCS to have a large  $\Delta k$  when this change is dominated by  $\Delta k_e$  (i.e.,  $\Delta \sigma_e$ ) in the transition.

There is also thermal conductivity contribution from the bipolar (combined electron-hole) thermal conductivity  $(k_{e+h})$  in the solid semiconductors, through bipolar diffusion of the thermally excited electron-hole pairs<sup>3,4</sup> transporting additional thermal energy<sup>5</sup>. The photon conductivity becomes important at high temperatures and when the photon absorption coefficient is not small, but generally the conduction electrons absorb photons and here we assume the absorption coefficient is large and  $k_{ph}$  is negligible. So, the total thermal conductivity in solid is  $k(s) = k_p + k_e + k_{e+h}$  and for liquid  $k(l) = k_f + k_e$ . Since  $k_{e+h}$  is bandgap and temperature dependent, it is negligible at low temperatures and then has an exponential temperature dependence<sup>4,5</sup>. So,  $Z_{\text{TCS}}$  can be limited through  $k_{\min} = k(s)$  with non-negligible  $k_{e+h}$ .

Here, we review and classify the identified and the potential TCS materials, and give some example of each. Then we seek optimal (high  $Z_{\text{TCS}}$ ) materials, based on the thermal energy transport mechanisms mentioned above, and use *ab initio* calculations and theoretical treatments to predict these transport properties and introduce the some high  $Z_{\text{TCS}}$ compounds based on melting transition.

#### **II. THERMAL CONDUCTIVITY SWITCHES (TCS)**

The  $Z_{\text{TCS}}$  combines  $\Delta k$  at a distinct temperature with large contrast before and after transition through the low  $k_{\min}$ , i.e.,

$$Z_{\rm TCS} = \frac{\Delta k}{k_{\rm min}}, \text{ TCS figure of merit.}$$
 (1)

The broad classification of the TCS is shown in Fig. 1, and thermal conductivity changes and  $Z_{\text{TCS}}$  for some notable materials with different transitions and mechanisms are shown in Fig. 2 at their distinct transition temperatures. Figure 2 gives the change in thermal conductivity (left axis) as well as  $Z_{\text{TCS}}$  (right axis) and transition temperature (lower axis) for a range of materials. The TCS are divided into passive or active based on the lack or existence of external forces or actions exerted on materials. For active, a distant force or mechanism causes the thermal conductivity jump. External forces, electric and magnetic fields and stress can change the thermal conductivity of materials. Change in thermal conductivity has been observed under electric field in the bees-wax during its solidifying<sup>6</sup>. The thermal conductivity of SrTiO<sub>3</sub> increases by an applied electric field only below 50 K<sup>7</sup>, because the transverse optical (TO) phonon mode degenerated with the longitudinal acoustic (LA) phonon mode is shifted upward by the electric field, weakening the TO–LA interaction, thus increasing the thermal conductivity. The orientation of a uniaxially aligned nematic liquid crystal (cyanobiphenyl, 5CB) changes due to an AC electric field<sup>8</sup> and because its thermal conductivity (albeit small) depends on its molecular orientation<sup>9</sup>, it can act at TCS.

The thermal conductivity of Cu wire is affected by magnetic field, with experiment at 4.2 K recording thermal conductivity decrease and in proportionality under such fields (and



FIG. 1. Classification of thermal conductivity switches (TCS) with some example materials. The active switches require an external force field or action and are divided based on that mechanism. In passive switches, rectification presents solid-state devices, while others are classified based on the phase transition and the mechanisms of the thermal conductivity jump.

the W-F law holding)<sup>10</sup>. They also mentioned negligible field effect on resin, because of the phonon transport dominance (insulator). However, Jin *et al.*<sup>11</sup> have shown that phonons are also affected by magnetic field. They measured thermal conductivities of InSb around 3 - 10 K with and without magnetic field (7 T), concluding that the decrease in thermal conductivity (up to 12% at 5.2 K) is due the anharmonicity of the interatomic bonds under magnetic field. They hypothesize that only the Grüneisen parameter is affected by the field (verified by the *ab initio* calculations). Note that the effect disappears above 9 K.

Simulations have revealed that the thermal conductivity of a ferroic-twinned thin film can be controlled reversibly by mechanical stress<sup>12</sup>. The shear deformation induces the vertical (perpendicular to the heat-flow direction) twin boundaries between the fixed two horizontal twin boundaries in the plastic regime and the emerged boundaries hinder the heat flow by acting as phonon barriers, and also the density of the boundaries can be controlled by the magnitude and direction of applied field.

The thermal conductivity of boron nanoribbon is changed at room temperature by wetting the interface with variable solutions<sup>13,14</sup>. Yang *et al.*<sup>14</sup> show that the thermal conductivity of double boron nanoribbon prepared with a mixture of reagent alcohol and deionized water increases, while that with isopropyl alcohol remains the same as that of single boron nanorib-

![](_page_5_Figure_0.jpeg)

FIG. 2. Thermal conductivity switch (change)  $|\Delta k|$  (left axis, blue) and TCS figure of merit  $|Z_{\text{TCS}}|$ (right axis, red) for some materials at distinct temperatures. The TCS mechanisms and the phase transitions are also shown. D is for dielectric, S is for semiconductor, M is for metal, s is for solid and l is for liquid. The negative  $Z_{\text{TCS}}$  indicates the decrease in thermal conductivity upon melting. Two of the highest  $Z_{\text{TCS}}$  materials, namely, the Ag-added CdSb and Zn<sub>3</sub>Sb<sub>2</sub>, are marked (yellow). The four bond classifications are also shown.

bon. To enhance the heat transfer in the film boiling regime, where the heat transfer rate is significantly reduced due to the Leidenfrost effect, it is suggested to attract the slightly levitated liquid (conducting) droplet by a concentrated electric in the gap and decreasing the vapor gap thermal resistance<sup>15</sup>. For thermal controller in small satellites, a MEMS thermal switch radiator is suggested<sup>16</sup> using a suspended thin membrane with a high emittance coating which contacts with the substrate when a sufficient electric field is applied (heat is emitted into space through the membrane while it is on). Also, Jia *et al.*<sup>17,18</sup> suggest microdevices of liquid-solid thermal switch by using liquid body between two plates and liquid initially on the lower plate and controlling the contact with top plate. Their earlier work<sup>17</sup> demonstrates this by an array of discrete liquid droplets which forms a continuous liquid film under mechanical compression between plates, and controlling the hydrophilic pattern size and droplet volume. Their later work<sup>18</sup> shows the device with a low-contact pressure switching created through the electroplating, considering the relation between the gap and the capillary force on the separated hydrophobic/philic walls.

There are two thermo-mechanical switches used in space cryogenic systems; one is a mechanical switch controlled by the contact between surfaces, and the other is the gas-gap heat switch<sup>19</sup> with a movable part. The moving part, controlled by <sup>3</sup>He gas with a miniature sorption pump and a permanent neodymium magnet, is the switch (connecting/disconnecting with its counterpart). Another thermal switch for the use in cryogenics is automatic heat switch<sup>20</sup> designed using the pressure dependence of gas thermal conductivity when the gap dimension is smaller than the mean free path of the gas (Knudsen effect). They shows that the thermal conductivity increases by a factor of 600 around 15 – 20 K, where the mean free path of nitrogen becomes shorter than the gap (0.5 mm). The gas thermal conductivity becomes independent of the pressure above that temperature. Other thermal/electrical switch uses thermal actuation materials with suitable volume change with temperature (preferably phase change materials) and bridges the gap between two ends<sup>21</sup>.

On the other hand, the thermal conductivities of passive TCS materials change during a transition. Superconductors are passive TCS materials due to their peculiar thermal conductivity behavior. The thermal conductivity of normal materials decreases gradually to zero at 0 K, but that of NbC<sub>0.97</sub> increases by two orders of magnitude as the temperature decreases below its superconducting transition temperature ( $T_c = 10$  K), due to reduction in phonon scattering of the conduction electrons<sup>22</sup>. The reduction can be explained by the BRT theory<sup>23</sup> of ultranarrow electronic bandgap developing below  $T_c$  reducing energy states, thus the probability of phonon-electron scattering decreases and the thermal conductivity increases<sup>22</sup>.

The thermal rectification has been widely studied<sup>24–26</sup> and these solid-state devices show the thermal conductivity transition with respect to the heat-flow direction. CNTs and BN-NTs were engineered to have a non-uniform axial mass by coating with amorphous  $C_9H_{16}Pt$ , so that they have asymmetric axial thermal conductance at room temperature<sup>24</sup>. The measured thermal conductance was always higher (2% for CNT and 3 - 7% for BNNTs) when heat flows from the higher-mass region to the lower-mass region. Similar geometrical treatment for VO<sub>2</sub> beam was tested and the nanoscale asymmetric VO<sub>2</sub> beam, which has one narrow end width and the other wider with a uniform thickness, showed that a difference of the thermal conductance with respect to the heat transfer direction of up to 28%, below the transition temperature (340 K), while there is no difference above that temperature<sup>25</sup>. This temperature-gated thermal rectification for the active heat flow control has been the highest rectification. A macroscopic thermal diode based on switchable thermal clocking can also control the thermal flow<sup>26</sup>. This device, which consist of alternating layers made of copper and expanded polystyrene, blocks the heat in one direction whereas it conducts well in the opposite direction, thus it acts as electronic diode.

The s/s transitions are accompanied by atomic structure changes; for example, the structure of NbO<sub>2</sub> is changed from a distorted rutile structure under temperature transition (1080 K) to a undistorted rutile structure, and the thermal conductivity increases<sup>27,28</sup>. Also, VO<sub>2</sub> has a monoclinic structure at low temperature under 340 K, while it is tetragonal at higher temperatures<sup>29,30</sup>. During the structural transition of NbO<sub>2</sub> and VO<sub>2</sub>, their  $\sigma_e$  increase undergoing semiconductor/metal (S/M) transition, increasing thermal conductivities as shown in Fig. 2. Liquid crystals have directional thermal conductivities and cyanobiphenyl (*n*CB) has s/s transition temperature (nematic below and isotropic above about 300 K) as the molecular arrangement changes<sup>9</sup>. It was found that the thermal conductivities of samples with a homeotropic orientation decrease at transition during heating, whereas those with a planar orientation increase, for n = 5 - 9 ( $|Z_{TCS}| < 0.5$ ). Also, the highly drawn crystalline (C<sub>2</sub>H<sub>4</sub>)<sub>n</sub> (polyethylene) is predicted (classical molecular dynamics) to a distinct decrease in thermal conductivity at 397 K<sup>31</sup>, and is dielectric/dielectric (D/D) transition.

The s/l phase transition (melting/solidification), can change the thermal conductivity though  $\Delta k_e$  and  $k_p - k_f$ , due to the absence of distinct lattice in liquid atomic structures (more pronounced than the s/s transitions). Although the  $k_p$  and the  $k_f$  contribute to the  $\Delta k$ , the  $\Delta k_e$  can be more much effective, so s/l phase transition is classified as D/D, S/S, S/M, and M/M. This is only the electronic mechanism, but shows the lattice contribution as well as characteristics of each transition; for example all the TCS with D/D and S/S in Fig. 2 possess negative  $Z_{\text{TCS}}$ , i.e.,  $k_p > k_f$  and without the significant increase in  $\sigma_e$ . However, all the S/M TCS (including the s/s transitions, e.g., NbO<sub>2</sub> and VO<sub>2</sub>) possess positive  $Z_{\text{TCS}}$ resulting from the substantial, positive  $\Delta k_e$  which overcomes  $k_p > k_f$ , due to the melting into metal. The elemental metals show M/M transition upon melting and have negative  $Z_{\text{TCS}}$  (expect Bi<sup>33</sup>), because the electron mobility decreases significantly upon melting.

### III. HIGH $Z_{\text{TCS}}$ WITH SEMICONDUCTOR/METAL (S/M) CONGRUENT MELT-ING TRANSITION

While large change in the thermal conductivity at a distinct temperature is important, it is also important for the TCS materials to have large contrast in conductivity, i.e., high ratio of thermal conductivity so the heat flux undergoes major change upon transition. So, it is required to have low  $k_{\min}$ . The s/l TCS should have congruent melting composition to ensure the reversibility for the cyclic melting/solidification. Here to achieve the highest  $Z_{\text{TCS}}$ , we consider the passive switch with bulk material (no size effects), and examine each mechanism within this area for the best TCS.

The s/s transitions present rather small change in the thermal conductivity (small  $Z_{\text{TCS}}$ ), i.e., the increase in  $k_e$  due to solid-state atomic structure transition does not notably affect to the thermal conductivity. Also, although the predicted high draw-ratio crystalline  $(C_2H_4)_n$ (polyethylene) shows high  $Z_{\text{TCS}}^{31}$ , the conventional polyethylene has a very low thermal conductivity  $(0.5 \text{ W/m K})^{58}$ . Therefore, in general it appears that the s/s transitions cannot yield high  $Z_{\text{TCS}}$ , although it should be mentioned that the high  $Z_{\text{TCS}} s/l$  transitions seem to be limited to high  $T_{sl}$ , thus some materials with these s/s transitions may be attractive.

Among the s/l transitions, the D/D and S/S transitions yield rather small change in thermal conductivity, as shown in Fig. 2. Although some of the examples show relatively large  $Z_{\text{TCS}}$ , it is due to the rather small  $k_{\min}$ , so their  $k (k_{\min} + \Delta k)$  does not exceed a few W/m K. The transition temperature depends on the bond type (molecular, ionic, metallic and covalent), and those are shown below the graph (Fig. 2). The ionic solids which have high  $T_{sl}$  lack significant free electrons so are poor conductors, e.g., NaF with relatively high  $Z_{\text{TCS}}$  among ionic solids. The molecular solids have strong intramolecular forces, thus are electric insulators, but have low  $T_{sl}$  due to weak intermolecular forces. The organic compounds and halogens are examples of molecular solids. The  $\sigma_e$  of ionic solids increases during melting, but is < 10  $1/\Omega$  cm<sup>39</sup>, so  $k_e$  gives negligible contribution. The  $Z_{\text{TCS}}$  of molecular and ionic solids are not high<sup>39,59</sup>, and are generally negative as mentioned before.

From the kinetic theory, for molecular solids with D/D mechanism (negligible  $k_e$  contribution), the ratio of the  $k_p$  to  $k_f$  at  $T_{sl}$  can be approximated as the ratio of the speed of sound in solid and liquid, considering their the density, specific heat and mean free path

remain the same  $^{59}$ ,

$$\frac{k_p}{k_f} \approx \frac{\omega_p}{\omega_f} \approx \frac{1}{\Delta \Omega^{1/3}} \exp\left(\frac{\Delta S_{\rm m}}{3k_{\rm B}}\right),\tag{2}$$

where  $\omega = u/d$  (*u* is the mechanical wave speed and *d* is the mean atomic space),  $\Omega$  is ordering factor to show the difference in the degree of ordering between phases,  $S_{\rm m}$  is entropy of melting, and  $k_{\rm B}$  is the Boltzmann constant. So,  $Z_{\rm TCS}$  for molecular solids is related to ratio of the speed of sound in solid and in liquid at  $T_{sl}$ .

InSe has the highest  $Z_{\text{TCS}}$  among the D/D and S/S transitions, i.e. 3.9. This is due to change between  $k_p$  and  $k_f$ , because the  $\sigma_e$  is low<sup>60</sup> and continuous across  $T_{sl}^{61}$ . Its solid  $\sigma_e$ increases with temperature, and then decreases from 823 K up to the  $T_{sl}$  (873 K). The phase diagram of the In–Se system<sup>62</sup> and the measured properties<sup>63</sup> show that a peritectic melting temperature (incongruent; a different solid phase occurs) of In<sub>4</sub>Se<sub>3</sub> marks this transition (823 K). Also, InSe undergoes a peritectic melting at 873 K and passes the liquidus curve near 900 K (the melting and liquidus points may vary)<sup>62–64</sup>. Therefore, InSe is not a good TCS material due to its irreversibility (non-cyclic) during the melting and solidifying.

The s/l, M/M transition materials (elemental metals) show the highest thermal conductivity change, due to the large change in the  $\sigma_e$  upon melting. For example, the highest  $|\Delta k|$ among the elements listed in Fig. 2 is 162 W/m K for Cu. The element with highest  $Z_{\text{TCS}}$  is Hg (3.0) at low temperatures. However, other than Hg, the  $|Z_{\text{TCS}}| < 1.4 \text{ (Cd)}^{32,53,57}$ , which is lower than elemental semiconductors (1.8 for Si and Ge), because the liquid  $\sigma_e$  is still large (large  $k_{\min}$ ). On the other hand, the S/M transition can have higher  $Z_{\text{TCS}}$  than any other TCS of materials with significant  $\Delta k$  upon melting (small  $\sigma_e$  of solid semiconductor and high  $\sigma_e$  of metallic liquid).

The epitome of these materials is cadmium antimonide (CdSb) as shown in Fig. 3 (reproduced)<sup>47,48</sup>. It melts congruently at 729 K<sup>62</sup>. The k(s) of CdSb is 2.0 W/m K and the liquid  $k_e$  is 9.4 W/m K (at  $T_{sl}$  for both), i.e.,  $Z_{\text{TCS}} = 3.7$  (higher when adding  $k_f$ ); a fairly high value for bulk material without small thermal conductivity in both solid or liquid phases. The large change in the thermal conductivity upon melting is due to the S/M transition, i.e., large  $\Delta k_e$  ( $\Delta \sigma_e$ ) (Fig. 3). The solid thermal conductivity increasing at 425 K, due to the  $k_{e+h}$  which becomes noticeable near 400 K<sup>48</sup>. The  $Z_{\text{TCS}}$  is further increased when the  $k_{e+h}$  is suppressed without decreasing the liquid  $\sigma_e$ . This was done with adding Ag atoms (0.1%) which suppressed the  $k_{e+h}$  of CdSb<sup>48</sup> (green curve in Fig. 3). The

![](_page_10_Figure_0.jpeg)

\* Experimental result, calculated by measured properties (k = αρC<sub>p</sub>) up to 600 K [48], and extrapolated up to T<sub>sl</sub>
<sup>#</sup> Calculated by W-F law using measured electrical conductivity [48], and extrapolated up to T<sub>sl</sub>
\* k<sub>p,e+h</sub> (s,S) = k (s,S) - k<sub>e</sub>(s,S) [48], the sum of k<sub>p</sub> and k<sub>e+h</sub>
\* By using measured electrical conductivity [47], k<sub>e</sub> is Calculated by W-F law

<sup>+</sup> by using incastice electrical conductivity  $[\pm 7]$ ,  $k_e$  is calculated by we hav <sup>+</sup> Actual  $\Delta k$  will be higher when the fluid particle thermal conductivity is also considered

<sup>§</sup> Experimental result for 0.1% Ag added CdSb [48]

FIG. 3. Measured thermal conductivities of pure CdSb as a function of temperature. The semiconductor/metal transition at  $T_{sl}$  causes a large increase in electronic thermal conductivity. Addition of 0.1% Ag to CdSb in the solid phase lowers the total thermal conductivity (by 0.8 W/m K at  $T_{sl}$ ).

results shows that the thermal conductivity is slightly larger than that without Ag at room temperature<sup>48</sup> (due to the increased  $n_{e,c}$ , so  $\sigma_e$ ), but much lower at high temperatures (1.2 W/m K at  $T_{sl}$ ), because  $k_{e+h}$  is suppressed effectively. However, the effect of the Ag addition on the liquid  $\sigma_e$  needs and will be examined in the Section VI. Then  $Z_{\text{TCS}}$  will be around 6.8 (higher when adding  $k_f$ ).

#### IV. ATOMIC-STRUCTURE METRICS OF S/M TCS

The phonon conductivity has a strong quadratic dependence on the molar composition<sup>65</sup>, but alloying drastically changes in the electronic properties and melting further changes those, e.g., CdSb, a high  $Z_{\rm TCS}$  semiconductor compound of metallic Cd and semimetal Sb, has a much lower thermal conductivity than its elements. It can be expected that the thermal conductivity is correlated with several properties which are also related to each other, thus it is important to understand and find the relations of thermal conductivity and fundamental properties. Figure 4 renders such metrics of high  $Z_{\rm TCS}$ . For semiconductors the charge effective mass  $m_{i,e}$  (i = e or h: electron or hole) is proportional to the bandgap ( $\Delta E_{e,g}$ ) and the alloy composition, the static dielectric constant ( $\varepsilon_{e,o}$ ) decreases linearly with  $\Delta E_{e,g}$ , and  $\Delta E_{e,g}(T)$  is linear (T > 150 K) with generally negative slope<sup>65</sup>. The effective mass influence the intrinsic charge carrier density ( $n_i \propto m_{i,e}^{3/2}$ ) and mobility ( $\mu_i \propto m_{i,e}^{-1}$ )<sup>2</sup>.

A low  $T_{\rm D}$  is preferred for TCS (low phonon conductivity), but covalent bond needed for solid semiconductor means high  $T_{sl}$  which is proportional to the square of  $T_{\rm D}$  ( $T_{sl} = C\langle M\rangle T_{\rm D}^2 d^2$ , Lindermann relation<sup>66</sup> for melting, where  $\langle M \rangle$  is the average atomic mass,  $d^3 = V_a$  is average volume per atom, and C is a constant)<sup>67</sup>. The strong bond leads to the high  $T_{sl}^{67}$  and large  $\Delta E_{e,g}^{68}$ . In the report<sup>68</sup>, 18 III-V and II-VI compounds show that increase in the atomic number decrease  $T_{sl}$  and  $\Delta E_{e,g}$  due to expansion of the overlapped atomic potentials leading to the close coupling of the atoms (also, the higher  $T_{sl}$ , the larger  $\Delta E_{e,g}$ ).

![](_page_11_Figure_2.jpeg)

FIG. 4. The optimal S/M melting transition TCS requirements including thermal conductivity for solid and liquid phases. The covalent bonds in solid phase and metallic in liquid phase allow for the electron local-/delocalization, as shown in the ELF and charge density distributions.

Low k(s) leads to high  $Z_{\text{TCS}}$ , and  $k_p$  increases with  $T_{sl}$  and decreases with increase in atomic mass ratio of the constituents<sup>69</sup>. So, compounds with moderate and heavy elements result in high  $Z_{\text{TCS}}$ . While large  $\Delta E_{e,g}$  gives small intrinsic  $k_e$ , moderate  $\Delta E_{e,g}$  is sought to avoid high  $T_{sl}$ . CdSb has  $\Delta E_{e,g}$  of 0.5 eV. However, the moderate  $\Delta E_{e,g}$  can results in significant  $k_{e+h}$  at high temperatures. So, intervention is needed to suppress  $k_{e+h}$ . Although large  $\Delta E_{e,g}$  can give high  $Z_{\text{TCS}}$ , but larger than 4.0 (AlSb in Fig. 5) may not be possible due to very large  $k_p$ .

The simple estimation of the  $k_{e+h}$  is<sup>70</sup>

$$k_{e+h} = A \exp\left(\frac{-E_{e,g}^*}{2k_{\rm B}T}\right),\tag{3}$$

where A is a constant and  $E_{e,q}^*$  is the bandgap for the bipolar diffusion. The relation shows that the  $k_{e+h}$  will not be negligible if the temperature is sufficiently high, so the  $k_{e+h}$  can be suppressed by increasing the bandgap<sup>4,5</sup>. However, this increases  $T_{sl}$  and  $T_D$ , increasing solid thermal conductivity. Rather, it is preferred for  $\Delta E_{e,g}$  to have a weak dependence on temperature (unlike CdSb) so that  $k_{e+h}$  can be less effective (less thermal excitation of electrons) at high temperature, but having the S/M transition upon melting. Also,  $k_{e+h}$ can be suppressed with the size effect<sup>71</sup>; the nano-PbS suppresses the  $k_e$  and  $k_{e+h}$  due to the electron scattering at high-density grain boundaries<sup>72</sup>, but here we remain with bulk homogeneous materials. In addition to the CdSb, small addition of Ag to PbSe reduces  $k_p$ by the point-defect scattering and electron-phonon coupling, and  $k_{e+h}$  by increasing the hole (majority) density leading to decrease in the Seebeck coefficient<sup>48,73</sup>. This can be interpreted with the fact that the  $k_{e+h}$  is maximized when the  $\sigma_i$  contributions from electrons and holes are equal<sup>3</sup>, thus the unbalancing  $\sigma_i$  can reduce the  $k_{e+h}$ . Though, suppressing of  $k_{e+h}$ is effective with minority-carrier manipulation<sup>74</sup>; decrease in  $m_{i,e}$  (by doping) and  $\mu_i$  (by microstructure refinement or interface modification) of minority carriers reduces  $it^5$ . These show that  $k_{e+h}$  is minimized when the minority carriers are hindered from participating in conduction<sup>75</sup>. In the report<sup>75</sup>, band-engineering with heterostructure barriers is suggested as barrier for minority carriers, while the effect on majority carriers is negligible. So, doping for the unbalance by decreasing  $m_{i,e}$ ,  $\mu_i$ , and  $n_{i,c}$  of the minority carrier, and lowering the temperature dependence of  $\Delta E_{e,g}$ , is effective in suppressing the  $k_{e+h}$ , with the additional advantage to reducing  $k_p$  by the point-defect scattering.

The large change in  $\sigma_e$  at  $T_{sl}$  occurs when solid semiconductors makes a metal transition

upon melting. This electron delocalization has history back in Wigner in 1938 suggesting that a free-electron gas should crystalize at low densities (localized in a non-conducting state), and Mott in 1949 discussed this transition (so called, Mott transition) with a crystalline array of monovalent atoms such that the array must be an insulator for large values of lattice parameter and a metal when it reaches to a critical value<sup>76</sup>. According to the Mott transition<sup>76</sup>, the transition must be discontinuous because electron-hole pair can form because of their Coulomb attraction,  $-e_c^2/\varepsilon_e r_{eh}$ , where  $\varepsilon_e$  is the background dielectric constant and  $r_{eh}$  is distance, and the binding energy of order  $m_e e_c^4/\hbar^2 \varepsilon_e^2$ , where  $m_e$  is the electron mass and  $\hbar$  is the reduced Planck constant. The transition occurs when  $n_{e,c}^{1/3}R_{\rm B} \approx 0.2$ , where  $R_{\rm B} = 0.53\varepsilon_e/(m_{e,e}/m_e)$  is the Bohr radius. It shows that the transiton occurs when the  $n_{e,c}$ and  $\varepsilon_e$  is large or the  $m_{e,e}$  is small. But large solid  $n_{e,c}$  (large  $k_e$ ) is not desired, and the  $m_{i,e}$ should be tuned so that both  $k_e$  and  $k_{e+h}$  are reduced. so,  $\varepsilon_e$  is key in the binding of the electron-hole, and is worth examining near the transition.<sup>77</sup>

Although Mott mentioned that the transition is not always discontinuous<sup>76</sup>, Mott and Davis<sup>76,78</sup> argued that the transition of semiconductors is a Mott transition, taking account of the disorder of a random array of atoms, and  $\varepsilon_e$  tending to infinity at transition. From Adachi<sup>65</sup>, the  $\varepsilon_e$  semiconductors increases as  $\Delta E_{e,g}$  decreases, then  $\varepsilon_e$  of CdSb will increase with temperature<sup>79</sup> and tends to infinity as  $\Delta E_{e,g}$  vanishes upon melting, leading to significant dielectric screening of the Coulomb attraction of the electron-hole pair. Also, the transition should be discontinuous, because solid  $\Delta E_{e,g}$  which is about 0.2 eV at  $T_{sl}$  for CdSb suddenly disappears (metallic liquid). Therefore, the CdSb undergoes the Mott transition upon melting, and this is expected for other S/M transition TCS materials.

The other theory describing the criteria for the insulator-metal transition of many liquid alloys is the Ioffe-Regel limit. The scattering of electrons becomes weak due to the screening of the ionic potentials when the  $n_{e,c}$  is sufficiently large [nearly free electron (NFE) metals], and there is a limit where the scattering becomes strong<sup>80</sup>. The electrical conductivity limit  $(\sigma_{\text{limit}})$  at this point is about 3000  $1/\Omega$  cm for typical liquids and the  $\sigma_e$  follows  $\sigma_{\text{limit}}/\eta$ , where  $\eta$  is the Korringa enhancement  $(\eta > 1)$  under the Ioffe-Regel limit ( $\sigma_e < \sigma_{\text{limit}}$ ), where the transport becomes diffusive. Therefore, the  $\sigma_{\text{limit}}$  can be considered as the metallic liquid regime for the S/M transition, and favorable TCS materials will have the  $\sigma_e$  higher than  $\sigma_{\text{limit}}$ . It should be noted that this theory may not sufficiently consider the remaining shortrange order clusters in the metallic liquid; it is expected from this theory that the liquid alloys with  $\sigma > \sigma_{\text{limit}}$  are NFE metals (ideal metallic behavior), but the liquid CdSb has a semiconductor behavior of the  $\sigma_e$ , even though  $\sigma_e > \sigma_{\text{limit}}^{47}$ .

The electronic localization function (ELF) and the charge density distribution present clues for evaluating the behavior of valance electrons of materials in terms of the local-/delocalization. As shown in Fig. 4, the localized electrons can be seen as the formation of bond attractors in the ELF and the overlapped charge density distributions between atoms in semiconductors, whereas the network of channel which encloses the attractors in the ELF and the spherical charge density distribution stand for the metallic behavior (see Section VI). The origin of the  $\Delta E_{e,g}$  is the local-/delocalization of valence electrons (due to the nature of orbitals and its contribution to the bonding). As shown in Fig. 11 and 12, the S/M transition of CdSb is mainly due to the 5p orbital of Sb atom, same as the semimetal/metal transition of elemental Sb (see Section VI). Considering binary semiconductor compounds including CdSb, it is expected that the combinations of metal and semimetal/semiconductor elements provide the p orbital (S/M transition) for high  $Z_{\text{TCS}}$ . Investigation for existing materials shows six compounds with the  $Z_{\text{TCS}} \geq 1.8$ , i.e., elemental Ge and Si; CdSb, InSb,  $Ge_2Sb_2Te_5$ , GaSb, and AlSb, in Fig. 2. The most interesting feature is that all the compounds possess Sb as base element. Also, all of them except  $Ge_2Sb_2Te_5$  are the binary Sb compounds with metallic elements. Therefore, it is believed that Sb is one of the most promising semimetal/semiconductor elements for binary TCS materials, and we call such elements as the TCS base element.

To determine possible TCS base elements, the metalloid elements (B, Si, Ge, As, Se, Sb, and Te) are searched for large  $\Delta k$  upon melting. The usual Boron-based semiconductors are III–V compounds (BN, BP, BAs, and BSb) with significantly high  $k_p$ ; the *ab initio* calculation result<sup>81</sup> shows that their  $k_p$  are higher than 500 W/m K at room temperature and that of BAs is comparable to that of diamond, due to their strong bond which yields large  $T_{sl}$  and  $T_D$ . So, they cannot possess high  $Z_{TCS}$ . The available data show that Se and Te are not suitable since the highest liquid  $\sigma_e$  among most telluride and some selenide semiconductors is less than 3000  $1/\Omega$  cm, and many selenide compounds remain semiconductors upon melting<sup>60</sup>. In the report<sup>60</sup>, it is mentioned that the chemical binding remains strong and they cannot be considered as the system of free-electron model, similar to CdSb but with much lower  $\sigma_e$ . So, selenides and tellurides do not have large  $\sigma_e$  jump upon melting. The common binary semiconductor compounds of Si or Ge are SiSe, SiSe<sub>2</sub>, GeSe, GeSe<sub>2</sub>, and GeTe. As discussed, the GeSe is a liquid semiconductor and the highest liquid  $\sigma_e$  of GeTe is < 3000  $1/\Omega \text{ cm}^{60}$ . The  $\sigma_e$  of Ge–Se system decreases as the Se composition increases<sup>82</sup>, so GeSe<sub>2</sub> is also a liquid semiconductor. Also, the liquid  $\sigma_e$  of the SiSe and SiSe<sub>2</sub> are almost close to those of the GeSe and GeSe<sub>2</sub>, respectively, which implies that the SiSe and SiSe<sub>2</sub> are also semiconductors<sup>83</sup>. There is no congruent melting composition for the binary compounds of Si or Ge with metal elements in groups  $12 - 15^{84}$ . Therefore, the Si and Ge can be excluded from the TCS base elements. The remaining metalloid elements are the As and Sb, and they do not make a distinct binary compounds with congruent melting<sup>84</sup>. It is expected that As would be TCS base element, same as Sb since both are semimetals in group 15.

Figure 5 lists properties of binary compounds (with congruent melting) based on the As and Sb with metal elements in groups 12 - 15. The metallic elements in the sixth row (Hg – Bi) are not included because they do not form a distinct congruent melting compounds (The As–Hg phase diagram is unknown<sup>85</sup>)<sup>62</sup>. Sn compounds are also excluded because there is no congruent melting compound in the Sn–Sb system<sup>62</sup> and congruent melting compounds of the Sn–As system<sup>62</sup> (SnAs and Sn<sub>4</sub>As<sub>3</sub>) are metallic<sup>86,87</sup>. Although ZnAs<sub>2</sub> and Cd<sub>3</sub>As<sub>2</sub> are congruent compounds in each system, the k(s) of ZnAs<sub>2</sub> is much higher than that of Zn<sub>3</sub>As<sub>2</sub> due to the significantly small Grüneisen parameter<sup>88</sup>, and the Cd<sub>3</sub>As<sub>2</sub> is a metallic solid with the high  $\sigma_e$  at room temperature<sup>88,89</sup>.

Considering the group 13–Sb compounds from InSb to AlSb (upward), their  $T_{sl}$  increases since the bond is strengthened with lighter elements, so the bandgap and  $T_{\rm D}$  should increase. Because they have the same lattice structure<sup>62</sup>, their Grüneisen parameters are expected to be similar, so their  $k_p$  should increase from InSb to AlSb. The contrary trend is in solid  $\sigma_e$  decreasing due to  $\varepsilon_e$  and bandgap; the decrease in the  $\varepsilon_e$  implies the increase in the Coulomb attraction and the weaker dielectric screening, so  $\sigma_e$  decreases. Although there is no data for the solid  $\sigma_e$  of AlSb, it should be lower than that of GaSb. So, the electron contribution to the k(s) decreases, whereas the lattice contribution increases. However, the liquid  $\sigma_e$  increases due to the same trend as the solid and liquid  $\sigma_e$  of each pure element  $(\sigma_{e,Al} > \sigma_{e,Ga} > \sigma_{e,In})^{53}$ , and the liquid  $k_e$  increases notably since the  $T_{sl}$  also increases (W–F law). Because  $k_f$  is negligibly small, dominant contribution to k(l) is  $k_e$ . So, AlSb has a high  $Z_{\rm TCS}$  about 4.0, although it has a significantly large contribution from  $k_p$  and high  $T_{sl}$ . The reason for the lowest  $Z_{\rm TCS}$  of GaSb among them is that both  $k_p$  and  $k_e$  are not negligible, so k(s) is almost the same as that of AlSb.

![](_page_16_Figure_0.jpeg)

\* Slack relation with available data [62,87]

<sup>§</sup> W-F law with available  $\sigma_e$  data

<sup>†</sup> Extrapolation from data

 $k_f$  is calculated by Bridgman theory [1] using measured speed of sound and molar volume [102,103]

 $k_f$  is calculated by Bridgman theory [1] using bulk modulus obtained by *ab initio* calculations (see section V)

<sup>¶</sup> Expected values (see Section VII)

FIG. 5. Periodic table for binary TCS compounds based on As and Sb. The incongruent melting compounds are excluded. The TCS related properties of the compounds are listed. There are periodic trends for properties and CdSb and  $Zn_3Sb_2$  stand out. The As compound data are rare due to their reactivity and toxicity.

The group 13–As compounds have the same trends for properties as those of the 13–Sb compounds; increasing  $T_{sl}$  and bandgap and the decreasing  $\varepsilon_e$ . Also, the solid  $\sigma_e$  decreases and the liquid  $\sigma_e$  increases (no data for AlAs). These uniform trends are due to the same composition with same elemental group. The other important trend is that the  $\sigma_e$  of 13–As at liquid are lower than those of 13–Sb (the solid  $\sigma_e$  is lower or similar) due to higher liquid  $\sigma_e$  of elemental Sb compared to that of As<sup>53,90</sup>. So, it is expected that the k(s) of AlAs is higher than that of GaAs due to increase in  $k_p$  (but negligible decrease in  $k_e$ ), and a liquid  $\sigma_e$  much lower than AlSb, so  $Z_{\text{TCS}}$  not higher than AlSb (4.0). The reason for the higher  $Z_{\text{TCS}}$  of GaAs compared to InAs (not the same trend as the 13–Sb) is a much lower electrical contribution to k(s) for GaAs (low solid  $\sigma_e$ ), so they have similar k(s). Therefore, the highest  $Z_{\text{TCS}}$  material in group 13 is the AlSb, the same  $Z_{\text{TCS}}$  as pure CdSb.

The CdAs<sub>2</sub> is a possible TCS in the Cd–As system, but its predicted k(s) is slightly larger than CdSb, and it is expected that its liquid  $\sigma_e$  is lower than CdSb (due to high As content and higher  $\sigma_e$  for antimonides compared to arsenides). So,  $Z_{\text{TCS}}$  of CdAs<sub>2</sub> should be lower than CdSb (the data for CdAs<sub>2</sub> is limited). Also, CdSb can have higher  $Z_{TCS}$  with Ag addition, as discussed. Similarly, liquid  $\sigma_e$  of Zn<sub>3</sub>As<sub>2</sub> will be smaller than Zn<sub>3</sub>Sb<sub>2</sub>. However, most of  $\text{Zn}_3\text{Sb}_2$  properties are not known<sup>91,92</sup>. Since k(s) of  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub><sup>93</sup> is much smaller than  $Zn_3As_2$  and k(s) of  $Zn_3Sb_2$  is not expected to be higher (see below),  $Z_{TCS}$  of  $Zn_3As_2$  is smaller than  $Zn_3Sb_2$ . The reason for the low k(s) of CdSb and  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub> (essential to the high  $Z_{TCS}$ ) is their electron-poor nature<sup>48,91</sup>. Since there are 3.5 electrons per atom, the weak multicenter bonds are formed in CdSb to make up for this, leading to nonuniform atomic bonds and the strong anharmonicity<sup>48,94</sup>. The main structure of  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub> is the rhombohedral  $Zn_{36}Sb_{30}$  with an electron deficiency, so the balance is corrected by the interstitial Zn atoms which yield disorder as defects and the soft and anharmonic bonding<sup>91,95,96</sup>. Therefore, the k(s) of CdSb and  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub> are rather low. Similarity is expected between  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub> and  $Zn_3Sb_2$ . Whereas  $\beta$ - $Zn_4Sb_3$  has three interstitial Zn atom sites (36 available positions for each site) in the unit cell<sup>95</sup>, there are 18 Zn atom sites (8 available positions for each site) in  $Zn_3Sb_2$  (with larger unit cell) and only one of them has the full occupancy<sup>97</sup>. So, a more disordered structure with a stronger anharmonic bonding is expected for the  $Zn_3Sb_2$ , and thus the k(s) of  $\text{Zn}_3\text{Sb}_2$  would not be higher than  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub>.

From the discussions above, Sb is the best TCS base element due to its anharmonic bonding characteristics with group 12 elements, and higher liquid  $\sigma_e$  of antimonides than arsenides, leading to high  $Z_{\text{TCS}}$ . Among antimonides,  $\text{Zn}_3\text{Sb}_2$  and CdSb have high  $Z_{\text{TCS}}$ . Next we discuss about analyze related properties of CdSb in Section VI and  $\text{Zn}_3\text{Sb}_2/\beta$ - $\text{Zn}_4\text{Sb}_3$  in Section VII.

#### V. AB INITIO CALCULATION METHOD

The *ab initio* calculations are implemented by the Vienna *ab initio* Simulation Package  $(VASP)^{105}$  and the ABINIT packages<sup>106,107</sup>. The VASP is used for the relaxation of atomic structures, electron density of states  $(D_e)$  and band structures, ELF, *ab initio* molecular dynamics (AIMD), and bulk modulus. The Perdew-Burke-Ernzerhof (PBE)<sup>108</sup> exchangecorrelation functional is used along with the projector augmented wave (PAW) method<sup>109,110</sup> with 300 eV cut-off energy. The DFT-D3 method<sup>111,112</sup> with the Becke-Johnson damping for the van der Waals correction is adopted to obtain accurate results, since the cleavage planes inside CdSb are interconnected by the van der Waals interaction<sup>48</sup>. The usual density functionals are unable to describe the van der Waals correctly<sup>113</sup>, and the calculations can be improved drastically with the van der Waals density functional<sup>114</sup>. In the  $D_e$  and band structure calculation, the modified Becke-Johnson (mBJ) exchange potential<sup>115,116</sup> is included with non-spherical contributions from the gradient corrections inside PAW spheres (LASPH=.TRUE., in the VASP tag), since the mBJ often results in aspherical charge densities<sup>113</sup>. Our predicted bandgap energy for CdSb only with PBE functional was very poor, less than 0.1 eV significantly different to the experimental results (about 0.5 eV), and the previous reports  $^{48,94}$  show that the mBJ can predict the correct  $D_e$  and band structure.

For CdSb, the  $\Gamma$ -centered grids with  $8 \times 6 \times 6$  **k**-points are used for the relaxation of the atomic structure, and the relaxed structure is used to calculate the  $D_e$  with expanded  $30 \times 24 \times 24$  **k**-points for accuracy and the band structure with **k**-points along the Brillouin zone edges, but  $4 \times 3 \times 3$  **k**-points are used for  $D_e$  calculations with supercell, considering that  $D_e$  results for the CdSb supercell do not vary with larger number of **k**-points. For pure Sb, the  $\Gamma$ -centered grids with  $13 \times 13 \times 5$  and  $33 \times 33 \times 13$  **k**-points are used for the relaxation and the  $D_e$  of the solid unit cell, and  $8 \times 8 \times 3$  **k**-points for the  $D_e$  of the liquid supercell. Also, for pure Cd, the  $\Gamma$ -centered grids with  $25 \times 25 \times 13$  **k**-points are used for the relaxation of the solid unit cell and  $7 \times 7 \times 6$  **k**-points for the  $D_e$  of the liquid supercell. For  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub>, the  $\Gamma$ -centered grids with  $3 \times 3 \times 3$  **k**-points are used for the structure relaxation, considering the

large unit cell size and the fact that the relaxed structure with larger number of k-points is almost the same.

The AIMD calculation is implemented with canonical ensemble (NVT) under the Nosè-Hoover thermostat at prescribed temperature and a 1 fs time step is used. The fermismearing method is adopted with the smearing width corresponding to the energy at prescribed temperatures. The only  $\Gamma$ -point is used for the AIMD<sup>117,118</sup>, and four snapshots are collected from the AIMD results at every 1 ps after reaching equilibrium (3 ps) to calculate properties of liquid phase<sup>118,119</sup>. The thermodynamic relation of the bulk modulus is  $E_p = V_o(dP/dV)$ , where  $V_o$  is the zero-pressure volume. The pressure data from the AIMD calculations for various volumes are used to obtain the  $V_o$  and the derivative of P with respect to V and to calculate the  $E_p$ , by following the method suggested<sup>120</sup>.

The ABINIT package with *conducti* code<sup>121,122</sup> embedded in the package is used to predict the real part of the  $\sigma_e$  for liquid CdSb by calculating the Kubo-Greenwood (K–G) formula<sup>123,124</sup> written as<sup>118</sup>

$$\sigma_e = \frac{he_c^2}{V} \sum_{\mathbf{k}',\mathbf{k}} \lim_{E \to 0} \frac{f(E_{\mathbf{k}'}) - f(E_{\mathbf{k}})}{E} \delta(E_{\mathbf{k}'} - E_{\mathbf{k}} - E) \langle \psi_{\mathbf{k}} | \hat{\mathbf{v}} | \psi_{\mathbf{k}'} \rangle \langle \psi_{\mathbf{k}'} | \hat{\mathbf{v}} | \psi_{\mathbf{k}} \rangle, \tag{4}$$

where h is the Planck constant,  $E_{\mathbf{k}}$  is energy (eigenvalue) of eigenstate  $\mathbf{k}$ ,  $f(E_{\mathbf{k}})$  is Fermi-Dirac occupancy function,  $\psi_{\mathbf{k}}$  is wave function of eigenstate  $\mathbf{k}$ , and  $\langle \psi_{\mathbf{k}} | \hat{\mathbf{v}} | \psi_{\mathbf{k}'} \rangle$  is velocity matrix elements. The  $\delta$ -function ensures the energy conservation of electrons, and the  $\hat{\mathbf{v}}$  can be expressed by Hamiltonian gradient as<sup>118</sup>

$$\hat{\mathbf{v}} = \frac{1}{\hbar} \frac{\partial \mathbf{H}}{\partial \boldsymbol{k}}.$$
(5)

The calculations are implemented with snapshots obtained by the VASP AIMD calculations for each temperature. The PBE exchange-correlation functional is used along with PAW method, with 408 eV (15 Hartree) cut-off energy and  $2 \times 2 \times 2$  **k**-points of Monkhorst-Pack grid. Our tests showed that results were not affected by further increases in cut-off energy and **k**-points. The  $\delta$ -function is treated by the Gaussian function with the broadening width of 0.03 Ha following the suggested method<sup>125</sup>, and the well-converged  $\sigma_e$  can be obtained without any unphysical fluctuations along frequencies.

#### VI. HIGH Z<sub>TCS</sub> CdSb

#### A. Atomic structure of CdSb

Solid CdSb has a small  $\Delta E_{e,g}$  (0.5 eV)<sup>94</sup>, very low phonon cutoff energy (21 meV)<sup>48,126</sup>, and its orthorhombic unit cell consist of 8 Cd and Sb atoms each having 5 neighbors, whereas there are only 2 Cd–Sb bonds for Cd atoms and 2 Cd-Sb and 1 Sb-Sb bond for Sb atoms within the sum of covalent radii for Cd (1.44 Å) and Sb (1.39 Å), respectively<sup>48,127</sup>. The *sp*3 hybridization has been suggested, but Ashcheulov *et al.*<sup>128</sup> claims inequivalent hybrid orbitals as linear combinations of *s* and *p* orbitals. Using the electron-localizability indicator (ELI-D), Wang *et al.*<sup>48</sup> shows there are collection of three covalent bonds (two-center bonds) and one three-center interaction (Cd–Sb–Cd), i.e., a shared lone electron pair and inducing the interlayered structure with anisotropic properties. They explained existence of the threecenter interaction is from the deficiency of valence electrons (3.5 electrons per atom).

The *ab initio* calculated structure is presented in Fig. 6, showing nonuniform atomic

![](_page_20_Figure_4.jpeg)

FIG. 6. Ab initio predicted structure of CdSb. (a) Orthorombic unit cell of solid with the charge density distribution. The contours are for 300 m $e_c/Å^3$ , and the covalent bonds are marked as rods. (b) Bond lengths and angles are also shown. A pair of electrons shared in the three–center interaction (Cd–Sb–Cd) is highlighted. The predicted lattice constants, bond lengths and angles are in good agreement with experiments (Table I).

Parameters	Ab Initio	Previous Reports	Error (%)
Lattice constants (Å)	a = 6.473	a = 6.469	0.06
	b = 8.308	b = 8.251	0.69
	c = 8.551	c = 8.522	0.34
Bond length, Cd–Sb (Å)	2.805	2.793	0.43
	2.838	2.824	0.50
	2.892	2.882	0.35
	3.124	3.127	0.10
Bond length, Sb–Sb (Å)	2.841	2.810	1.10
Bond length, Cd–Cd (Å)	3.132	3.136	0.13
Angle, Cd–Sb–Cd (deg.)	$\alpha = 103.3$	$\alpha = 103.9$	0.58
	$\beta = 111.3$	$\beta=110.4$	0.82
	$\gamma = 141.7$	$\gamma = 141.4$	0.21

TABLE I. Atomic structure properties of CdSb predicted by *ab initio* calculations and compared with experiments<sup>48,129</sup>. The maximum difference is 1.1%.

bonds and angles and anisotropy, more accurate than previous reports<sup>48,94</sup>, because the van der Waals interactions are included (Table I). Figure 6(a) shows that the contours of charge density distribution around Sb atoms is distorted (rounded triangular or tetrahedron), but around Cd it is spherical (slightly distorted) and Cd and Sb contours overlap due to the Cd–Sb covalent bonds. Figure 7 shows the structures of Cd and Sb, where the charge density distribution around Cd is spherical and around Sb is also spherical but linked between atoms. The bond length of Cd and Sb is 2.96 Å and 2.93 Å, respectively, larger than the covalent bonds. Considering the charge density distributions and bond lengths, these imply valence electrons of Cd are localized with those of Sb forming covalent bonds.

CdSb is the only stable one in the Cd–Sb system under phase transition<sup>128</sup>, i.e., congruent melting ( $T_{sl} = 729$  K). In the melt CdSb, clusters of short-range order remain<sup>130</sup>, consist of Cd<sub>x</sub>Sb<sub>y</sub> implying strong interactions (Cd–Cd or Sb–Sb clusters are not possible<sup>130</sup>). The softening effect by melting is weak and the difference between the  $k_p$  and  $k_f$  will be small. The liquid CdSb is rather isotropic with free-electron like transport properties<sup>60,131,132</sup>. Some bonds (especially shared electron pairs and Sb–Sb) dissociate upon melting and some un-

![](_page_22_Figure_0.jpeg)

FIG. 7. Charge density distributions of the solid (a) Cd and (b) Sb unit cell, predicted by *ab initio* calculations. The contours are for 300 m $e_c/Å^3$ . The shortest Cd–Cd and Sb–Sb separations are 2.96 Å and 2.93 Å, respectively. The result shows that the charge density distribution of CdSb (Fig. 6) is noticeably transformed, implying covalent bonding.

![](_page_22_Figure_2.jpeg)

FIG. 8. Atomic structure of liquid CdSb at 800 K after 6 ps of AIMD calculations, along with the charge density distribution. The contours are for 300 m $e_c/Å^3$ . The structure is random, and the overlapping isosurface region is significantly reduced. The Cd<sub>x</sub>Sb<sub>y</sub> clusters with bond lengths smaller than 2.9 Å are marked with rods.

bound valence electrons become delocalized and wander, i.e., metal-like.

AIMD calculations verify the liquid properties at 800 K, using  $2 \times 2 \times 2$  supercell (128 atoms) and the density of liquid supercell is set same as solid (actual 1% density difference<sup>103,133</sup> is comparable to relaxation error in Table I). Figure 8 is snapshot of liquid CdSb at 800 K with charge density distribution and most Cd show spherical distribution without overlaps, indicating metallic bonding and properties<sup>134</sup>. The charge density distribution around Sb is less distorted and most of its covalent bonds are dissociated, so its delocalized electrons contribute to transport.

#### B. Electronic structure of CdSb

The S/M transition features are described by the charge density distributions combined with the ELF which suggests classification of bonding based on the topological analysis<sup>135</sup>. The value of ELF is between 0 and 1, where 1 and 0.5 correspond to perfect localization and uniform electron gas<sup>135,136</sup>. The localization attractors are defined by the local maxima of local functions related to the Pauli exclusion principle and there are bonding and nonbonding attractors. The bonding attractors have point or circular shapes and indicate that the localized electrons are involved in bonds, whereas the non-bonding attractors have ring shapes. The metallic bonds form a 3-D network (trajectories) connecting all attractors as the ELF level decreases<sup>135</sup>. The metallicity identification may not always be reliable using the ELF; diamond carbon<sup>136</sup> and lithium<sup>135</sup> both show bond attractors at high ELF level and network of channels at low ELF level. Here with focus of the TCS on the S/M transition upon melting, there is almost no bond attractor in metallic liquids, so the discussion regarding metallicity of the liquid phases using the ELF is rather valid (see the CdSb as an example below). Although the solid CdSb does not show a network of channels, it is possible that the solid phases of other notable TCS materials do. In that case, the density of states (DOS) should also be examined to confirm a non-metallicity.

Figure 9 shows the ELF contours for solid CdSb, and the reducible localization domain, where the attractors merged within two neighboring Sb, are seen in Fig. 9(a). The network is formed within only one Sb-Sb bond, indicating CdSb cannot be metallic. As the ELF level increases, the bifurcations of attractors occur at a critical value<sup>135</sup>, and Sb–Sb bond attractor begins to separate at the critical level of 0.74. The Sb–Sb bond attractor is located

![](_page_24_Figure_0.jpeg)

FIG. 9. The ELF for solid CdSb unit cell showing the contours with the level of (a) 0.310, (b) 0.800, and (c) 0.835. The blue lines coincide with those in Fig. 6(b), and the broken bonds indicate bonding with adjacent cell. The reducible localization domain which merged bond attractors within nearest two Sb atoms in (a) begins to separate as the ELF level increases (bifurcation), and the attractors for Sb–Sb bond can be seen in (b) and for Cd–Sb bonds and Cd–Sb–Cd interaction in (c).

in the middle point of Sb–Sb bond, suggesting electrons forming covalent bond are localized [Fig. 9(b)]. The attractors for Cd–Sb bonds and Cd–Sb–Cd interaction (van der Waals) are fully separated at the ELF level of 0.835 [Fig. 9(c)]. All attractors are located on the bonding line<sup>135</sup> and are much close to Sb<sup>128</sup>, since the electronegativity of Sb (2.05)<sup>1</sup> is larger than Cd (1.69)<sup>1</sup> (electrons localized close to Sb). Two van der Waals attractors are very close to each other and facing partner (Cd), but contours are nonuniform; the van der Waals attractor with shorter interaction distance (2.892 Å) is much larger than the longer distance (3.124 Å). The shared lone electron pair in Cd–Sb–Cd interaction is more probable to be located near a Cd, leading to stronger van der Waals interaction and closer shorter bond.

Contrary to solid bond characteristics, the liquid attractors [Fig. 10(a)] around Sb are ring-type (not intact due to disorder), similar to non-bonding ring attractor<sup>135</sup>. There is no attractor between Sb–Sb pairs with bond length 2.647 Å [smaller than two times covalent radius of Sb (2.78 Å)], in Fig. 10(a). There are  $Cd_xSb_y$  clusters in liquid; the Cd–Sb pair with long bond length 3.082 Å forms the bond attractor between them (close to Sb). Based on the length, it may not be a covalent bond, but shows Cd–Sb interaction<sup>130</sup>. Fig. 10(b)

![](_page_25_Figure_0.jpeg)

Network of Channels (Trajectories)

FIG. 10. The ELF for liquid CdSb supercell showing contours with the level of (a) 0.835 and (b) 0.310. The partial volume of supercell, the same as that of solid CdSb unit cell, is presented for comparison to the solid ELF of Fig. 9. The bond lengths for two atom pairs are presented in (a) to show the different bond characteristics of solid and liquid. All attractors near the Sb atoms in (a) are merged into the reducible localization domain with the low ELF level in (b), forming a three-dimensional network.

shows the liquid metallic behavior with 3-D network connecting all attractors around Sb<sup>135</sup>. The ELF contours around the Sb–Sb pair with 2.647 Å [Fig. 10(a)] become closer as the ELF level decreases and finally merge each [Fig. 10(b)], but the bonding attractor between them is never formed. The ELF results suggest liquid CdSb is metallic.

The band structure and solid and liquid  $D_e$  from *ab initio* calculations are shown in Fig. 11. The highest-edge valence and lowest-edge conduction band are near X- and Z-point, and solid bandgap of 0.49 eV consistent with experiments/predictions<sup>48,94</sup>. The solid  $D_e$  shows that the 4*d* of Cd is intensely overlapped with 5*s* orbital of Sb, within deep electron energy states (-11 to -7 eV), similar to liquid Hg<sup>137</sup> (group 12 feature). These states consist of four narrow energy bands with high peaks and some narrow bandgaps between them, and the band with the largest peak is significantly contributed to Cd 4*d* (near -9 eV). So, these four peaks originate from Cd–Sb and Cd–Cd interactions and related electrons are localized in these deep bands. Many valence electrons are from Cd 4*d*, so band with Cd–Cd interaction has the highest peak.

There are two wide conduction and valence bands up and down from both gap ends and the Sb 5p makes most contribution to these bands, especially to upper side of the valence band, and also contributions of Cd 5s and 5p to those bands can be seen<sup>48</sup>. These bands are mainly originated from the Sb–Sb bond, but also the couplings of the Sb 5p with the Cd 5s and 5p through Cd–Sb also affect to the formation of valence and conduction bands, especially the Cd 5s for lower parts of valence and conduction bands and the Cd 5p for upper parts. The interactions between Sb–Sb and Cd–Sb contribute to the prohibited band-energy region, but not the interaction between Cd atoms.

The liquid CdSb  $D_e$  at 800 K in Fig. 11(b) is obtained by averaging of the snapshot results and shows the valence and conduction bands merged and bandgap disappears (metallic). The highest contribution near the Fermi level is the Sb 5*p*; the valley of partial Sb 5*p*  $D_e$  is fully

![](_page_26_Figure_2.jpeg)

FIG. 11. (a) Electronic band structure (the Fermi energy is set to be zero) and  $D_e$  of solid CdSb unit cell. The highest occupied and the lowest unoccupied bands are colored, and red dots are the edges of them. (b) The  $D_e$  of liquid CdSb supercell calculated with atomic structures from the AIMD results at 800 K. The liquid  $D_e$  is averaged over four snapshots, but results are very similar. Contributions of orbitals of constituent atoms (partial  $D_e$ ) are also shown. The partial  $D_e$  is obtained within Wigner–Seitz radius, so the sum of partial  $D_e$  is not equal to the total  $D_e$ . The bandgap disappears in the liquid phase, i.e., metal upon melting.

represented to total  $D_e$ . Figures 12(a) and (b) show solid and liquid (950 K) Sb  $D_e$ , with main contribution to the metallic transition upon melting from 5p orbital and the partial  $D_e$  of other orbitals barely changing. The phenomenon is similar to the changes in partial Sb  $D_e$  in CdSb upon melting. Also, the valley in Fig. 11(b) is observed in Fig. 12(b). The valence electrons of the Sb 5p orbital once localized in solid state by the interactions with the Cd 5s and 5p orbitals and the 5p orbital of other Sb atoms are delocalized, and these electrons contribute to the metallic behavior of liquid. Also, the Cd partial  $D_e$  in liquid CdSb are similar to those of liquid Cd [Fig. 12(c)], confirming that sole Cd contributes to

![](_page_27_Figure_1.jpeg)

FIG. 12. The  $D_e$  of (a) Solid Sb (unit cell), (b) liquid Sb (2×2×2 supercell at 950 K;  $T_{sl} = 904$  K), and (c) liquid Cd (3×3×2 supercell at 700 K;  $T_{sl} = 594$  K). The Fermi energy is set to be zero. The solid Sb is semimetal, considering the deep valley at 0 eV. After melting, the liquid Sb becomes a metal and the valley almost disappears. It shows that the overlap of charge density distribution between Sb atoms in liquid CdSb does not imply that Sb atoms are forming covalent bonds. The 4d orbital of the liquid Cd mainly contributes to the deep electron energy states, whereas the both 5s and 5p orbitals of Cd contribute to the states near the Fermi level.

the liquid metallic properties. Although gradual increase in 5s and decrease in 5p partial  $D_e$  of liquid Cd are observed, the shallow valleys in the partial  $D_e$  of Cd 5s and 5p can be found in compound [Fig. 11(b)]. This implies that not all Cd behave like liquid but some of them are engaged in Cd<sub>x</sub>Sb<sub>y</sub> clusters.

#### C. Transport properties of CdSb

The CdSb k(s) decreases up to 425 K then increases, as reviewed in Fig. 3<sup>48,138</sup>. Following the Slack relation  $(T^{-1})^1$  this increase is due to  $k_e$  and/or  $k_{e+h}$ , however,  $k_e$  is very small (about 0.2 W/m K<sup>48</sup>), so this is due to  $k_{e+h}$ . The thermal conductivities of the solid and liquid CdSb are obtained by the theoretical treatments, and each contribution is shown in Fig. 13. The  $k_f$  is derived from the kinetic theory<sup>1</sup>

$$k_f = \frac{1}{3} \rho_f c_{v,f} a_s \lambda_f,\tag{6}$$

where  $\rho_f$  is the fluid density,  $c_{v,f}$  is specific heat at constant volume,  $a_s$  is speed of sound in liquid, and  $\lambda_f$  is mean free path of fluid molecules. The Bridgman theory treats liquid as a simple cubic arrangement of atoms with its mean free path equal to the three times of mean atomic spacing, i.e.,<sup>1</sup>

$$k_f = \rho_f \frac{3R_g}{M} a_s \left(\frac{M}{\rho_f N_A}\right)^{1/3} = \frac{3R_g}{N_A^{1/3}} \frac{\rho_f^{1/6}}{M^{2/3}} \left(\frac{c_{p,f}}{c_{v,f}} E_p\right)^{1/2},\tag{7}$$

where  $R_g$  is the gas constant, M is molecular weight (here, in molar base),  $N_A$  is Avogadro number, and  $c_{p,f}$  is specific heat at constant pressure (usually  $c_{p,f} \approx c_{v,f}$  for liquid). The  $k_f$ of liquid CdSb estimated as 0.49 W/m K at  $T_{sl}$ , with M = 234.17 g/mol,  $a_s = 1748$  m/s, and  $\rho_f = 6.857$  g/cm<sup>3</sup>,<sup>103</sup> so in TCS,  $k_f$  is small, making negligible contribution compared to  $k_e$ .

The Slack relation  $k_{p,S}$ , which is extended from the Leibfried and Schlömann equation for complex lattices<sup>139</sup>, is<sup>1</sup>

$$k_{p,S} = \frac{3.1 \times 10^4 \langle M \rangle V_a^{1/3} T_{D,\infty}^3}{T \langle \gamma_G^2 \rangle N_o^{2/3}},$$
(8)

where  $T_{D,\infty}$  is the high temperature Debye temperature,  $\langle \gamma_G^2 \rangle$  is mode averaged square of the dimensionless Grüneisen parameter at high temperature, and  $N_o$  is number of atoms in

![](_page_29_Figure_0.jpeg)

\* Experimental result [48] by measured properties ( $k = \alpha \rho C_p$ ) up to 600 K, and extrapolated up to  $T_{sl}$ 

<sup>+</sup> Predicted by the Slack relation [1] with measured properties [128,137] and calculated Grüneisen parameter [93]

<sup>¶</sup>Minimum k<sub>p</sub> calculated by Cahill-Pohl model using measured lattice constants [128] and predicted phonon velocities [48]

<sup>#</sup> Experimental result [48] by W-F law using measured  $\sigma_e$  up to 600 K, and extrapolated up to  $T_{sl}$ 

<sup>£</sup> Predicted by the theoretical model (see text)

<sup>§</sup> Calculated by  $k = k_p(s, S) + k_e(s, S) + k_{e+h}(s, S)$ 

<sup>†</sup> Calculated by Bridgman theory [1] using measured speed of sound and molar volume [102]

<sup>‡</sup>  $k_e$  is Calculated by W-F law using suggested  $\sigma_e$  [47], and  $k(l,M) = k_f(l,M) + k_e(l,M)$ 

FIG. 13. Temperature dependence of the thermal conductivities of solid and liquid CdSb. The high  $Z_{\text{TCS}}$  is observed during the S/M transition. The  $k_e$  is estimated from the measured  $\sigma_e$ , whereas  $k_p$ ,  $k_f$ , and  $k_{e+h}$  are calculated using the theoretical models. The predicted and experimental (black circles) results for k(s) are also compared.

the primitive cell. The  $T_{D,\infty}$  and  $\langle \gamma_G^2 \rangle$  can be replaced by  $T_D$  and  $\langle \gamma_G \rangle^2$ , respectively. The properties  $\langle M \rangle = 117.058$  g/mol,  $V_a = 1/n$   $(n = N_o/abc$  where a = 6.469 Å, b = 8.251 Å, and c = 8.522 Å are lattice constants from the experiment<sup>129</sup> and  $N_o = 16$ ),  $T_{D,\infty} = 180$  K, and  $\langle \gamma_G \rangle = 1.82$  are used<sup>94,140</sup>. The  $k_p$  within 300 – 400 K is coincident to k(s) from the experiment due to negligible  $k_e$  and  $k_{e+h}$  at low temperatures. Though, the Slack relation underestimates  $k_p$  at high temperatures due to its simplicity  $(T^{-1})$ ;  $k_f > k_p$  (0.42 W/m K) at  $T_{sl}$ . Therefore, The actual decreasing rate of  $k_p$  with temperature is slightly lower than the Slack result.

The minimum  $k_p$  can be obtained from the Cahill-Pohl model with assumptions as a mean

free path of phonon equal to one-half of wavelength, no phonon dispersion, and dominant short length-scale interactions<sup>1</sup>, i.e.,

$$k_{p,\text{C-P}} = \left(\frac{\pi}{6}\right)^{1/3} k_{\text{B}} n^{2/3} \sum_{\alpha} u_{p,\alpha} \left(\frac{T}{T_{\text{D},\alpha}}\right)^2 \int_0^{T_{\text{D},\alpha}/T} \frac{x^3 e^x}{(e^x - 1)^2} dx,\tag{9}$$

where  $\alpha$  is the phonon branch,  $u_{p,\alpha}$  is phonon velocity, and  $T_{D,\alpha}$  is Debye temperature for each branch as

$$T_{\mathrm{D},\alpha} = u_{p,\alpha} \frac{k_{\mathrm{B}}}{\hbar} (6\pi^2 n)^{1/3}.$$
 (10)

The acoustic phonon velocities are  $u_{p,\alpha} = 1300$ , 1581, and 2988 m/s for two transverse and one longitudinal phonons in the vicinity of Brillouin zone center (no dispersion)<sup>48</sup>. The minimum  $k_p$  is almost flat in a wide range of temperature (Fig. 13) after reaching a plateau at  $T_{D,\alpha}^{1}$  (average of  $T_{D,\alpha} = 191$  K). The calculated  $k_{p,\min}$  is 0.35 W/m K, same as reported result<sup>48</sup>. The  $k_p$  calculated from Eq. 8 is nearly  $k_{p,\min}$  at  $T_{sl}$ . This low  $k_p$  is caused by the deficiency of valence electrons (3.5 electrons per atom) which results in the complicated structure (Fig. 6). The weak three-center bonding lead to small force constant and modulus which lower phonon velocities and  $T_D$ , and strong anharmonic branches which induce large Grüneisen parameter<sup>48,94</sup>. Also, the strong coupling between soft optical phonon and acoustic phonon enhances scattering and contributes to the low  $k_p^{48,94}$ .

A theoretical model is used for  $k_{e+h}$  prediction, i.e.,<sup>141,142</sup>

$$k_{e+h} = \frac{\sigma_e \sigma_h}{\sigma_e + \sigma_h} (\alpha_h - \alpha_e)^2 T, \tag{11}$$

where  $\sigma_i = n_i e_i \mu_i$  is the electrical conductivity of charge carrier *i* (carrier charge  $e_i$ ) and  $\alpha_i$  is Seebeck coefficient. The Seebeck coefficient for a single parabolic band is expressed as<sup>143,144</sup>

$$\alpha_{i} = \pm \frac{k_{\rm B}}{e_{c}} \bigg[ \eta_{i} - \frac{(\lambda_{i} + 5/2)F_{\lambda_{i} + 3/2}(\eta_{i})}{(\lambda_{i} + 3/2)F_{\lambda_{i} + 1/2}(\eta_{i})} \bigg], \tag{12}$$

where  $\lambda_i$  is the carrier scattering parameter ( $\lambda_i = -1/2$ , assuming acoustic phonon scattering),  $\eta_i$  is reduced Fermi energy, and  $F_\beta$  is Fermi integral of the order of  $\beta$ . The  $\eta_i$  and  $F_\beta$  can be written as<sup>143,145–147</sup>

$$\eta_e = (E_F - E_c)/k_{\rm B}T,\tag{13}$$

$$\eta_e + \eta_h = -\Delta E_{e,g}/k_{\rm B}T,\tag{14}$$

$$F_{\beta}(\eta_i) = \int_0^\infty \frac{x^{\beta}}{1 + e^{x - \eta_i}} dx, \qquad (15)$$

where  $E_F$  is the Fermi energy and  $E_c$  is conduction band energy. With the assumptions that  $(E_e - \mu) \gg k_{\rm B}T$  (electron energy  $E_e$  and chemical potential  $\mu$ ) and  $\mu$  is analogous to  $E_F$ , then  $n_i$  can be derived theoretically as<sup>2</sup>

$$n_i = 2 \left(\frac{m_{i,e} k_{\rm B} T}{2\pi\hbar^2}\right)^{3/2} \exp\left(\eta_i\right). \tag{16}$$

The  $m_{i,e}$  for electrons at conduction band minimum and for holes at valence band maximum toward each direction<sup>148</sup> were averaged by the geometric mean (density of state effective mass<sup>149</sup>) with degeneracy factors of 2 for valence band and 6 for conduction band from band structure [Fig. 13(a)]<sup>94,149,150</sup>. The temperature dependent bandgap energy  $(-6 \times 10^{-4} \text{ eV/K}$ and 0.45 eV at room temperature)<sup>79</sup> was used with constant Fermi level position (0.032 eV / 0.46 eV)<sup>151</sup>, and  $\mu_i$  was extrapolated from the measured data  $(100 - 280 \text{ K})^{152}$  and mobilities of hole and electron are the same<sup>153</sup>. The extrapolated  $\mu_i$  has the temperature dependence of  $T^{-1.4}$  consistent to previous claims  $(T^{-1.5})^{154}$ , and is about 350 cm<sup>2</sup>/V s at 300 K similar to the measured mobility (300 cm<sup>2</sup>/V s at 300 K)<sup>155</sup>. The estimated k(s) is similar to the reported result<sup>48</sup> at the low temperatures. The reason is because of the steep increase in  $k_{e+h}$ estimated; actual  $k_{e+h}$  will increase gradually from 400 K, and the discrepancy would occur due to the  $\mu_i$  extrapolation in a wide range of temperature (300 –  $T_{sl}$ , lack of data). We believe that the result can be improved with precise mobility data, and  $k_{e+h}$  prediction is meaningful for distinguishing and assessing each contribution to k(s).

The solid  $\sigma_e$  starts increasing near 400 K (thermal excitation of electrons) and is about 180 1/ $\Omega$  cm at  $T_{sl}$  (Fig. 14), equivalent to 0.2 W/m K. The liquid  $\sigma_e$  is about  $5.2 \times 10^3 1/\Omega$ cm at  $T_{sl}^{47,60}$ , in the metallic regime<sup>80</sup> and equivalent to 9.4 W/m K. Although its electronic properties like Hall coefficient and thermoelectric power are metallic<sup>131</sup>, the semiconductor behavior of liquid  $\sigma_e$  (increasing with temperature) is observed due to the short-range order interactions in low temperature liquid CdSb<sup>60</sup>. The liquid  $\sigma_e$  increases as a logarithmic function (Fig. 14); semiconductor behavior becomes weak and the short-range interactions reduce as temperature increases<sup>156</sup>. Thus, liquid  $\sigma_e$  will start decreasing eventually when the clusters of short-range order totally disappear and metallic behavior begins. The previous reports<sup>128,157</sup> indicate that it occurs at 773 K, so there is a contradiction with the experiment<sup>47</sup>. We believe that the disappearance point is higher than 890 K because of the evidence for the presence of clusters in liquid  $D_e$  at 800 K [Fig. 11(b)]. Also, the data<sup>156</sup>

![](_page_32_Figure_0.jpeg)

FIG. 14. Temperature dependence of the  $\sigma_e$  for solid and liquid CdSb. The significant rise in  $\sigma_e$  (high  $Z_{\text{TCS}}$ ) is observed during the S/M transition at  $T_{sl}$ . The liquid  $\sigma_e$  increases with temperature, due to some remaining short-range order interactions (Cd<sub>x</sub>Sb<sub>y</sub> clusters). The discrepancy between the experiment and the *ab initio* prediction for  $\sigma_e$  is due to the assumptions in the K–G formulation (ideal metallic transport).

shows that liquid specific heat is higher than predictions by the Neumann–Kopp law (the weighted average with fractions of constituents) over 890 K, the same as  $\sigma_e$ , due to the short-range order. Therefore, the disappearance point is expected to be above 890 K.

The liquid  $\sigma_e$  is obtained at several temperatures (750 – 900 K) using the K–G formula with snapshots of AIMD calculations (Fig. 14). The *ab initio* prediction, however, shows metallic behavior (decreasing with temperature) and higher values than the experiment. This is due to the assumption of the K–G formula, derived from the Kubo formula with the approximation of non-interacting Fermi system for the current operator<sup>158</sup>. It suggests that the K–G formula is suitable only for perfect crystal without inelastic processes, but the scattering between the electrons and the phonons always occurs in the semiconductor<sup>158,159</sup>. Also, the formula cannot directly describe zero  $\sigma_e$  for localized states<sup>159</sup>. Therefore, the result shows that the predicted  $\sigma_e$  is for ideal metallic behavior (NFE metal) without any consideration of remaining short-range interactions. Although there is a large discrepancy, the result can be used to assess the liquid  $\sigma_e$  for the Ag-added CdSb not reported so far (see next section).

The estimated k(s) and k(l) at  $T_{sl}$  are 2.0 and 9.9 W/m K, respectively, and lead to  $Z_{\text{TCS}} = 4.0$ . The high thermal conductivity jump is achieved by the transition from solid semiconductor to liquid metal (metallic melting). Also, the electron-poor characteristic yields high  $Z_{\text{TCS}}$  by lowering the  $k_p$  contribution. Therefore, CdSb is one of the notable TCS materials. Furthermore, the  $Z_{\text{TCS}}$  can be enhanced by suppressing  $k_{e+h}$  by adding Ag. We will discuss about the transport characteristics of Ag-added CdSb in the next section.

#### D. Effect of Ag addition on CdSb

The point-defect (impurity) scattering is considered to predict  $k_p$  for Ag-added CdSb. The impurity in base material, called static imperfection<sup>1</sup>, hinders phonon transport, thus lowers  $k_p$ . The effect of point-defect scattering is found using the relation  $1/k_p(x) = 1/k_p(0) + 1/k_{p,d}^{160}$ , and  $k_{p,d}$  is found from<sup>161,162</sup>

$$k_{p,d} = \frac{k_{\rm B}}{4\pi u_{p,g,A} (a_1 CT)^{1/2}},\tag{17}$$

where  $u_{p,g,A}$  is the acoustic phonon group velocity,  $a_1$  is coefficient for the Reyleigh pointdefect scattering, and CT is relaxation time for interphonon scattering. These parameters can be written as<sup>1,160–162</sup>

$$\frac{1}{u_{p,g,A}} = \frac{1}{3} \left( \frac{1}{u_{p,g,LA}} + \frac{1}{u_{p,g,TA1}} + \frac{1}{u_{p,g,TA2}} \right),$$
(18)

$$a_1 = \frac{V_c \Gamma}{4\pi u_{p,q,A}^3},$$
(19)

$$\Gamma = \sum x(1-x) \left(\frac{M(\mathbf{X})}{M_c}\right)^2,\tag{20}$$

$$CT = \frac{(6n)^{1/3}k_{\rm B}}{2\pi^{4/3}k_p(0)},\tag{21}$$

where LA and TA denote for the longitudinal and transverse acoustic,  $V_c$  is unit cell volume,  $\Gamma$  is mass fluctuation scattering parameter, x and M(X) are fraction and mass of added atom X, and  $M_c$  is mass of an average cluster. It can be assumed that the average unit cell volume and phonon group velocities of materials with small content of impurity (small x) are almost the same as pure base material (negligible effect). For unit cell  $Cd_{8-x}Sb_8Ag_x$ ,  $M_c = (8-x)M(Cd) + xM(Ag) + 8M(Sb)$ , where M(Cd) = 112.411, M(Ag) = 107.868, and M(Sb) = 121.760 g/mol. Using x = 0.008 (0.1%),  $u_{p,g,A} = 1450$  m/s (for entire Brillouin zone)<sup>94</sup>, and the Slack relation for pure CdSb to the  $k_p(0)$ ,  $k_p$  for 0.1% Ag-added CdSb is predicted in the Fig. 15. The calculated  $k_p$  is slightly lower than  $k_p$  for pure CdSb, 0.06 and 0.02 W/m K at 300 K and  $T_{sl}$  (about 5%), respectively. This shows addition of Ag does not change  $k_p$  significantly. It is expected that the  $k_f$  is also lowered because the speed of sound will decrease, but the effect is minor. We assume  $k_f$  is the same as  $k_p$  at  $T_{sl}$ , which makes it lower than pure CdSb, this way  $Z_{TCS}$  is slightly underestimated.

The solid  $k_e$  (Fig. 15) of Ag-added CdSb is 0.8 W/m K at  $T_{sl}$  much higher than pure CdSb (0.2 W/m K), thus the addition of Ag atom exerts effect to the solid-state electronic structure. The estimated  $k(s) = k_p + k_e$  is almost the same to the experimental result<sup>48</sup>, and suggests that  $k_{e+h}$  is significantly decreased. This is because of increase in hole concentration which leads to decrease in Seebeck coefficient<sup>48,73</sup> and unbalanced  $\sigma_e$  between majority (hole) and minority (electron) carriers. So, although  $k_e$  increases, k(s) decreases highly about 0.8 W/m K, due to the considerable decrease in the  $k_{e+h}$ . Therefore,  $Z_{\text{TCS}}$  can enhance noticeably, provided that the liquid  $\sigma_e$  is still as high as that of pure CdSb.

The liquid  $\sigma_e$  of Ag-added CdSb at 800 K is calculated by the K–G formula, with the same method used for pure CdSb. Two Cd atoms in the CdSb supercell are replaced by Ag atoms (3.1%) positioned as far as possible between them. Note that such a small addition is hard to be realized by *ab initio* calculations due to large system size. The result shows that the predicted  $\sigma_e$  at 800 K is 8074 1/ $\Omega$  cm almost the same as pure CdSb (8164 1/ $\Omega$ cm), and should be the same for 0.1% Ag addition. Because the short-range order will not change with small content of Ag atom, the *ab initio* calculations suggest that the addition of Ag atom does not affect to the electron transport properties of liquid CdSb and  $k_e$  is the same as pure CdSb (9.4 W/m K at  $T_{sl}$ ).

The estimated k(s) and k(l) at  $T_{sl}$  are 1.2 and 9.9 W/m K, respectively, and lead to  $Z_{TCS}$ = 7.3 for the 0.1% Ag-added CdSb, significantly higher than that of pure CdSb (4.0) due to the  $k_{e+h}$  suppression. Therefore, the TCS performance of CdSb can be enhanced by the addition of Ag atom.

![](_page_35_Figure_0.jpeg)

<sup>†</sup>Assumption;  $k_f(l,M)$  the same as  $k_p(s,S)$  at  $T_{sl}$ 

<sup>\*</sup>  $k_e$  the same as that of pure CdSb, and  $k(l,M) = k_f(l,M) + k_e(l,M)$ 

FIG. 15. Temperature dependence of the thermal conductivities for the 0.1% Ag-added CdSb for the solid and liquid phase. The  $k_e$  is estimated from the measured  $\sigma_e$ , whereas the  $k_p$  is predicted by the Slack relation with the point-defect (impurity) scattering. The predicted and experimental (black circles) results for k(s) are compared, along with those for pure CdSb. The liquid  $k_e$  is the same as that of pure CdSb, since the liquid  $\sigma_e$  predicted by the K-G treatment did not change by added Ag.

#### VII. HIGH $Z_{TCS}$ $Zn_3Sb_2$

#### A. Lattice and transport properties of $Zn_4Sb_3$

Zn–Sb compounds (ZnSb, Zn<sub>4</sub>Sb<sub>3</sub>, and Zn<sub>3</sub>Sb<sub>2</sub>) are known as semiconductors<sup>163</sup> undergoing metallic melting<sup>52</sup>, and first two are thermoelectric (TE) materials for their low thermal conductivity<sup>95,96,164–167</sup>. Their liquid  $\sigma_e$  at  $T_{sl}$  is higher than Cd–Sb<sup>52</sup>, so large  $Z_{\text{TCS}}$  is expected when k(s) is low near  $T_{sl}$ . While ZnSb undergoes incongruent melting, Zn<sub>3</sub>Sb<sub>2</sub> data

![](_page_36_Figure_0.jpeg)

<sup>§</sup> Calculated by Bridgman theory [1] using measured speed of sound and molar volume [103]

<sup>†</sup>  $k_e$  is Calculated by W-F law using suggested  $\sigma_e$  [52] and  $k(l,M) = k_f(l,M) + k_e(l,M)$ 

FIG. 16. Temperature dependence of the thermal conductivities of  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub> for the solid and liquid phase, assuming that the transport characteristic of  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub> is the same as  $\gamma$ -Zn<sub>4</sub>Sb<sub>3</sub>. The  $k_p$  is rather very small, due to the interstitial Zn atoms which cause considerable phonon scattering. Also, the dependence of solid  $k_e$  on temperature make it small, coming from solid  $\sigma_e$  decreasing with temperature increase (Fig. 17). However, the liquid  $k_e$  is larger than that of CdSb.

is rare<sup>92</sup>, but its  $Z_{\text{TCS}}$  is expected not to be smaller than the better known  $\text{Zn}_4\text{Sb}_3$ . So we examine structure and transport characteristics of Zn<sub>4</sub>Sb<sub>3</sub> comparing with Zn<sub>3</sub>Sb<sub>2</sub>. Zn<sub>4</sub>Sb<sub>3</sub> has several solid phases (transitions between  $\alpha/\beta$  and  $\beta/\gamma$  occur at 253 K and 763 K) and melts at 857  $K^{168}$ . We analyze yet better known TE  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub> with rather low thermal conductivity 0.75 W/m K over a wide temperature range (Fig. 16), unlike CdSb, i.e.,  $k_{e+h}$ is negligible is due to the large bandgap  $(1.0 \text{ eV}^{88})$ .

The low  $k_p$  of  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub> is due to its complicated structure which has uncertainty due to partial occupancy of Zn atoms, and the stoichiometry is not 4:3 but rather 3.95:3<sup>95</sup>. The main structure is rhombohedral as  $Zn_{36}Sb_{30}$  with the electron deficiency<sup>91</sup>, and Sb atoms

![](_page_37_Figure_0.jpeg)

FIG. 17. Temperature dependence of  $\sigma_e$  of the solid and liquid  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub>, with significant rise (high  $Z_{\text{TCS}}$ ) in the S/M transition at  $T_{sl}$ . The solid  $\sigma_e$  decreases with temperature because the mobility decreases considerably, and that of liquid increases with temperature as CdSb due to the short-range order interactions.

have full occupancy at each site but Zn1 atoms have 90% occupancy. There are three additional interstitial sites for Zn atoms (Zn2, Zn3, and Zn4) with partial occupancy of about 5% (36 available positions for each site). These interstitial Zn atoms make up for the electron-poor nature of main structure so that the charge balance is achieved<sup>91</sup>. Therefore, the partially occupied interstitial sites lead to significant point-defect scatterings<sup>96</sup>. Because of its soft and anharmonic bonding (loosely-bound Zn atoms), the ionic conductivity is high and Zn atoms will move to vacancies easily (leading to less-ordered structure), and the Sb dumbbells (vertical Sb–Sb bonds)<sup>169</sup> cannot rattle independently<sup>96,166</sup>. Also, there are nanovoids or nanoparticles of Zn or ZnSb within the structure<sup>96</sup> causing significant phonon scattering.

Its solid  $k_e$  is also small over a wide range of temperature, since its  $\sigma_e$  decreases with temperature<sup>93,96,170–172</sup> (Fig.17) due to the decay in electron mobility<sup>96</sup> compensating for increase in charge density. The acoustic phonon scattering is the source for the reduced

mobility<sup>96</sup>. This can be associated with the partially occupied Zn atoms moving to vacancies more frequently as temperature increases and the atomic structure becomes much lessordered, thus much active phonon-electron scattering as well as phonon-phonon scattering is expected as temperature increases. In addition, its smaller solid Lorenz number than metals or heavily doped semiconductors  $(1.86 \times 10^{-8} \text{ W} \Omega/\text{K}^2 \text{ at } 300 \text{ K})^{172}$  leads to small solid  $k_e$ . Its liquid  $\sigma_e$  is about 5500  $1/\Omega \text{ cm}^{52}$  and  $k_e$  is 11.5 W/m K (higher than CdSb due to the higher  $\sigma_e$  and  $T_{sl}$ ). The  $\sigma_e$  data (Fig. 17) and the previous reports<sup>104,173</sup> show that clusters of short-range order remain (same as CdSb), so liquid  $k_e$  increases with temperature (Fig. 16). Using the Bridgman model and data<sup>104</sup> on speed of sound and molar volume give  $k_f = 0.26 \text{ W/m K}$  at  $T_{sl}$ , slightly lower than  $k_p$  at  $T_{sl}$  (0.34 W/m K).

These transport properties of  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub> give high  $Z_{\text{TCS}} = 14.7$ , the highest identified yet for bulk, passive TCS, if the transport characteristics of  $\gamma$ -phase are the same  $\beta$ -phase and the structure is stable at  $T_{sl}$ . There is controversy about its congruent melting<sup>88,168</sup> and it can be due to its instability. The Zn atoms may sublimate decomposing into ZnSb and Zn before melting<sup>165,168</sup>. However, its high-temperature was claimed recently<sup>167</sup>; some Zn–Sb bonds break over 425 K and  $\beta$ -phase becomes mixture of Zn and ZnSb, but it will become stable again over 565 K by reactions between ZnSb with Zn, when the structure of  $\beta$ -phase is not decomposed too much between 425 and 565 K.

We perform *ab initio* studies of the stability of  $\beta$ -phase at high temperature to shed light. The structure has the space group of R3c and the lattice constants are a = b = 12.228 Å and c = 12.407 Å<sup>95</sup>. The structure for the *ab initio* calculations is reconstructed by substituting three Zn1 atoms with six interstitial Zn atoms (two Zn atoms for each interstitial site) following recent study<sup>174</sup>. This Zn<sub>39</sub>Sb<sub>30</sub> model possesses the occupancies for each Zn site (91.7% and 5.6% for main and interstitial sites, respectively) almost the same as those reported. The relaxed structure of  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub> is presented in Fig. 18. Its lattice constants are a = b = 12.422 Å and c = 12.518 Å, almost the same as experiment<sup>95</sup>, and and the bond lengths are similar to the previous *ab initio* calculation<sup>174</sup> (Table II). The bond length of interstitial Zn atoms are shorter than the main sites; 2.666 – 2.997 Å for Zn1–Sb, 2.659 – 2.935 Å for Zn1–Zn1, and 2.853 – 2.958 Å for Sb–Sb atoms. The measured length of Sb rattling dimers (six dumbbells in the unit cell) is 2.82 Å<sup>95,168,169</sup> and we have a slightly longer dimer lengths 2.853 – 2.872 Å, and 2.958 Å due to distortion by Zn3 and Zn4 atoms (differences are less than 2%). The AIMD is implemented for the relaxed unit cell structure

TABLE II. Atomic structure properties of  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub> predicted by *ab initio* calculations and compared with experiments<sup>95</sup> for lattice constants, and with previous *ab initio* results<sup>174</sup> for bond lengths.

Parameters	Ab Initio	Previous Reports	Error (%)
Lattice constants (Å)	a = 12.422	a = 12.228	1.59
	c = 12.518	c = 12.407	0.89
Bond length, Zn2–Zn3 (Å)	2.50	2.52	0.79
Bond length, Zn2–Zn4 (Å)	2.50	2.58	3.10
Bond length, Zn3–Zn4 (Å)	2.62	2.63	0.38

at 700 K for 4 ps (Movie I<sup>175</sup>). The result shows that the Zn and Sb are not fixed at their prescribed positions; they wander inside the unit cell and the structure is not stable. So, we cannot observe stable  $\beta$ -phase lattice structure at high temperatures, and it would be possible that Zn<sub>4</sub>Sb<sub>3</sub> melts incongruently.

![](_page_39_Figure_3.jpeg)

FIG. 18. Ab initio prediction of the  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub> structure and its charge density distribution. The contours are for 300 me<sub>c</sub>/Å<sup>3</sup>. (a) Rhombohedral unit cell, where the vertical Sb–Sb bonds are dimers. (b) Top view of the structure. The Zn1 and Sb are atoms in the main structure, while Zn2, Zn3, and Zn4 are interstitial atoms. The predicted lattice constants and the bond lengths are in good agreement with available results (Table II).

#### **B.** Lattice and transport properties of $\mathbf{Zn}_3\mathbf{Sb}_2$

Although  $Zn_4Sb_3$  may not be a TCS material due to the instability, its transport characteristics suggest the possibility of the highest  $Z_{\text{TCS}}$  from the Zn–Sb system, especially for the high-temperature stable  $Zn_3Sb_2$  compound with congruent melting<sup>91,104</sup> at 853 K<sup>62</sup>. Recent report<sup>97</sup> regarding the structure of  $Zn_3Sb_2$  suggests its TCS suitability. The structure is orthorhombic, and has six atomic sites for Sb atoms and 18 for Zn atoms in the interstices made by Sb atoms (8 available positions for each site). The atomic sites for Sb atom have full occupancy, but the only one site for Zn has the full occupancy. Considering the partial occupancies for other Zn atoms, the actual composition of  $Zn_3Sb_2$  is  $Zn_{2.66}Sb_2 =$  $Zn_4Sb_3$ , almost the same as  $Zn_4Sb_3$  ( $Zn_{3.95}Sb_3$ ) but with slightly larger Zn content. There are 48 Sb in the unit cell of  $Zn_3Sb_2$  and only 8 Zn are fully occupied, so there are additional 56 Zn (on average) at 136 possible positions in the unit cell. Thus,  $Zn_3Sb_2$  has a significantly lower-ordered structure, more complicated, and larger unit cell than  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub>. So, stronger anharmonicity, softer bonding, and higher ionic conductivity compared to  $Zn_4Sb_3$ is expected with vigorous phonon-phonon and phonon-electron scatterings. Therefore, the  $k_p$  and solid  $\sigma_e$  would not higher than those of  $\beta\text{-}\mathrm{Zn}_4\mathrm{Sb}_3.$  Also, considering the actual composition, it is evident that the liquid  $Zn_3Sb_2$  and  $Zn_4Sb_3$  have similar transport properties, i.e.,  $Zn_3Sb_2$  should have same k(l) as  $Zn_4Sb_3$ . The previous report<sup>52</sup> marked as  $Zn_3Sb_2$  for liquid properties at 40% atomic fraction of Sb, but we believe that this is due to the lack of information for the structure and actual composition of  $Zn_3Sb_2$  at that time. Therefore, it is expected that the  $Z_{\text{TCS}}$  of  $\text{Zn}_3\text{Sb}_2$  is not smaller than  $\text{Zn}_4\text{Sb}_3$  ( $Z_{\text{TCS}} = 14.7$ ), and because of its stability it is anticipated that  $Zn_3Sb_2$  is a promising TCS material.

#### VIII. CONCLUSIONS

After a review of TCS materials, focusing on s/l phase change we note that transition with non-electronic transport  $(k_p \text{ and } k_f)$  offer near room temperature  $T_{sl}$ , but not high  $Z_{\text{TCS}}$ , i.e., electronic transitions are preferred. Between M/M and S/M transitions, although M/M presents the highest  $\Delta k$ , S/M has the best potential for highest  $Z_{\text{TCS}}$ . The low  $k_p$ , absence of  $k_{e+h}$ , and large jump in  $k_e$  (i.e.,  $\sigma_e$ ) during the s/l, S/M transition are required to obtain high  $Z_{\text{TCS}}$ . While examining potential semiconductor compounds, we found that combinations of metal and semimetal/semiconductor elements are promising, especially with the semimetal elements (Sb and As) as the base elements. The binary antimonide and arsenide compounds with metal elements in group 12-15 are then investigated. The Sb is superior due to the higher  $\sigma_e$  of antimonides compared to arsenides (with the same metal element), and the Ag-added CdSb and possibly Zn<sub>3</sub>Sb<sub>2</sub> have the highest  $Z_{\text{TCS}}$  (7.2 and 14.7, respectively).

Due to the electron-poor nature, the CdSb structure has nonuniform bond lengths and angles, and its three-center interaction (Cd–Sb–Cd) induces low phonon velocities and the strong anharmonicity, so the  $k_p$  of CdSb is low and its  $Z_{\text{TCS}}$  can be high. Using the charge density distribution and ELF, the electron local-/delocalization characteristics of the solid and liquid phases were demonstrated. In solid CdSb, the valence electrons are localized in the Cd-Sb and Sb-Sb covalent bonds, and one electron pair is shared in the three-center interaction, but the pair is more probable to be located on one side with a shorter bond length. It is expected that the Cd atoms act as a metal in the liquid CdSb and contribute to its metallic properties, as in elemental liquid Cd. The ELF confirms that CdSb undergoes metallic melting and the retained short-range order interactions are for Cd<sub>x</sub>Sb<sub>y</sub> clusters (the Sb–Sb cluster does not exist). Also, the  $D_e$  reveals that the main contribution to the bandgap in the solid and in the metallic liquid is the 5p orbital of the Sb atoms.

The thermal conductivities in solid and liquid CdSb are obtained from existing experimental results and from theoretical and *ab initio* calculations. The  $\Delta k_e$  is the main contribution to the high thermal conductivity jump, and the  $k_{e+h}$  is estimated and distinguished from the  $k_p$ . It has been reported that the addition of Ag (0.1%) can significantly reduce  $k_{e+h}$ , and our *ab initio* calculations with the K-G formulation reveals that the liquid  $\sigma_e$  of Ag-added CdSb is the same as that of pure CdSb. Therefore, we confirmed that the  $Z_{\text{TCS}}$  can be notably enhanced by the Ag addition and becomes 7.2.

The Zn–Sb compounds have higher  $\sigma_e$  compared to the Cd–Sb system, and lower  $k_p$ . Specifically,  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub> has a significantly low k(s) of about 0.75 W/m K, due to the partial occupancy of the main and interstitial Zn atoms (which induce a very large unit cell, soft and anharmonic bonding, and active phonon scattering). However, Zn<sub>4</sub>Sb<sub>3</sub> cannot be a TCS due to its structural instability at high temperatures and its incongruent melting. Although there is almost no data for the stable Zn<sub>3</sub>Sb<sub>2</sub>, it is expected that it has lower k(s) compared to  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub>. The structure of Zn<sub>3</sub>Sb<sub>2</sub> is more disordered than  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub> since it has 17 Zn atom sites with partial occupancies and larger unit cell, so much more pronounced anharmonicity, softer bonds and higher ionic conductivity are expected, so we expect its k(s) will not be larger than that of  $\beta$ -Zn<sub>4</sub>Sb<sub>3</sub> and should have  $Z_{\text{TCS}}$  higher than 14.7. We hope there will future, detail transport characterization of Zn<sub>3</sub>Sb<sub>2</sub> as a distinct TCS material (and also high-temperature, high  $Z_{\text{TE}}$  material).

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